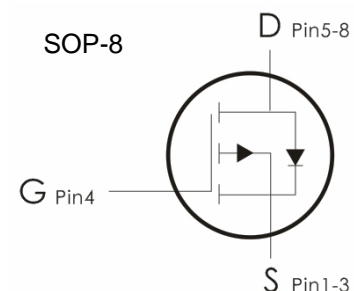
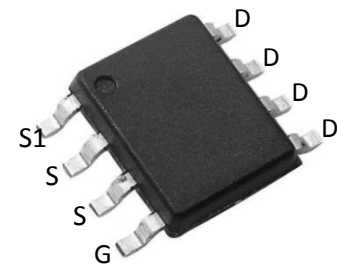


P-Channel 30 V (D-S) MOSFET

Description:

This P-Channel MOSFET uses advanced trench technology and design to provide excellent $R_{DS(on)}$ with low gate charge.

It can be used in a wide variety of applications.



Features:

- 1) $V_{DS}=-30V, I_D=-15A, R_{DS(ON)}<9.5m\ \Omega$ @ $V_{GS}=-10V$
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra $R_{DS(ON)}$.
- 5) Excellent package for good heat dissipation.

Absolute Maximum Ratings: ($T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	-30	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Continuous Drain Current- $T_C=25^\circ C$	-15	A
	Continuous Drain Current- $T_C=100^\circ C$	-7.8	
	Pulsed Drain Current ¹	-52	
E_{AS}	Single Pulse Avalanche Energy	---	mJ
P_D	Power Dissipation	4.2	W
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ C$

Thermal Characteristics:

Symbol	Parameter	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	30	$^\circ C/W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	60	

Electrical Characteristics: ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\ \mu\text{A}$	-30	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{GS}=0V, V_{DS}=-30V, T_J=25^\circ\text{C}$	---	---	-1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0A$	---	---	± 100	nA
On Characteristics						
$V_{GS(th)}$	GATE-Source Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\ \mu\text{A}$	-1.0	-1.6	-2.5	V
$R_{DS(on)}$	Drain-Source On Resistance ²	$V_{GS}=-10V, I_D=-10A$	---	8	9.5	$\text{m}\Omega$
		$V_{GS}=-4.5V, I_D=-8A$	---	12.4	15	
G_{FS}	Forward Transconductance	$V_{DS}=-10V, I_D=-10A$	---	13	---	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS}=-15V, V_{GS}=0V, f=1\text{MHz}$	---	3300	4800	pF
C_{oss}	Output Capacitance		---	410	700	
C_{rss}	Reverse Transfer Capacitance		---	280	500	
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time ^{2,3}	$V_{DS}=-15V, V_{GS}=-10V$ $I_D=-1A, R_{GEN}=6\ \Omega$	---	24.5	38	ns
t_r	Rise Time ^{2,3}		---	10.5	16	ns
$t_{d(off)}$	Turn-Off Delay Time ^{2,3}		---	156.8	230	ns
t_f	Fall Time ^{2,3}		---	50	75	ns
Q_g	Total Gate Charge ^{2,3}	$V_{DS}=-15V, V_{GS}=-4.5V,$ $I_D=-10A$	---	35	56	nC
Q_{gs}	Gate-Source Charge ^{2,3}		---	10.8	16	nC
Q_{gd}	Gate-Drain "Miller" Charge ^{2,3}		---	10.6	18	nC
Drain-Source Diode Characteristics						
V_{SD}	Source-Drain Diode Forward Voltage ²	$V_{GS}=0V, I_S=-1A, T_J=25^\circ\text{C}$	---	---	-1	V

Notes:

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width \cong 300us , duty cycle \cong 2%.
3. Essentially independent of operating temperature.

Typical Characteristics: ($T_C=25^\circ\text{C}$ unless otherwise noted)

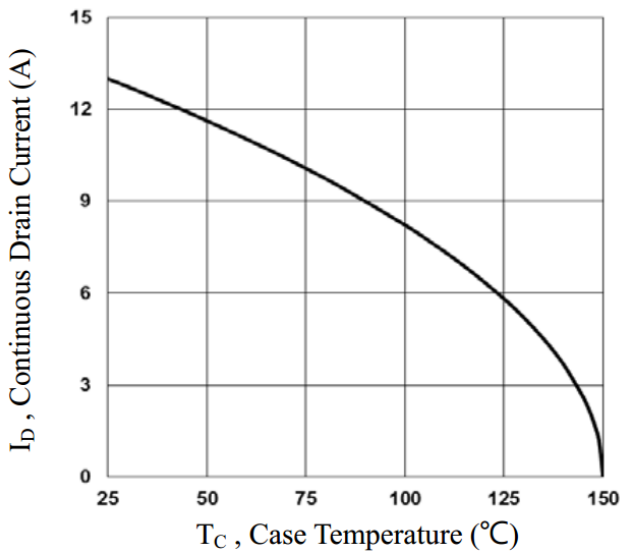


Fig.1 Continuous Drain Current vs. T_C

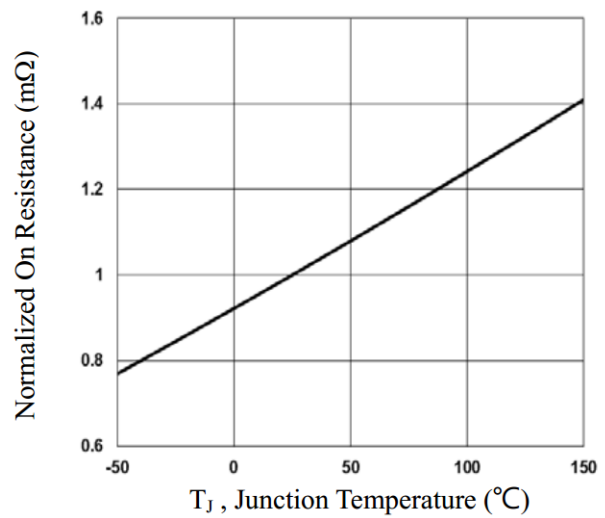


Fig.2 Normalized $R_{DS(on)}$ vs. T_J

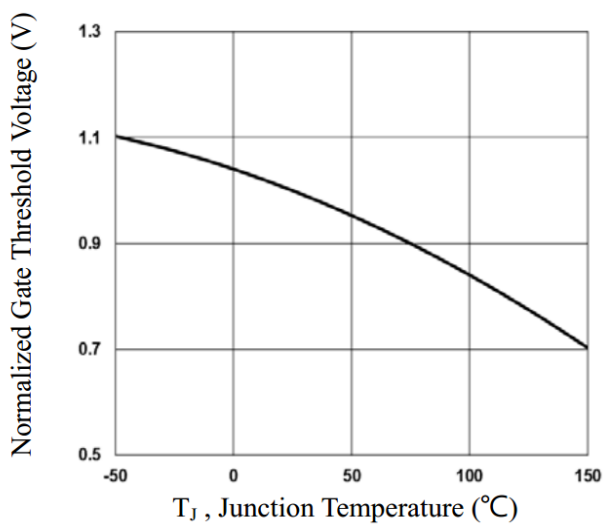


Fig.3 Normalized V_{th} vs. T_J

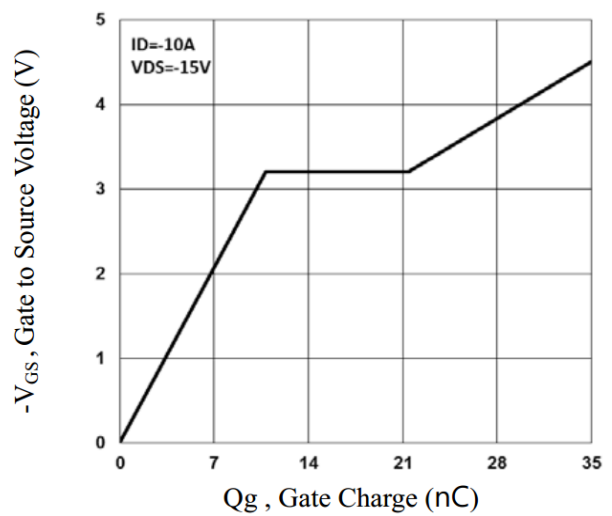


Fig.4 Gate Charge Waveform

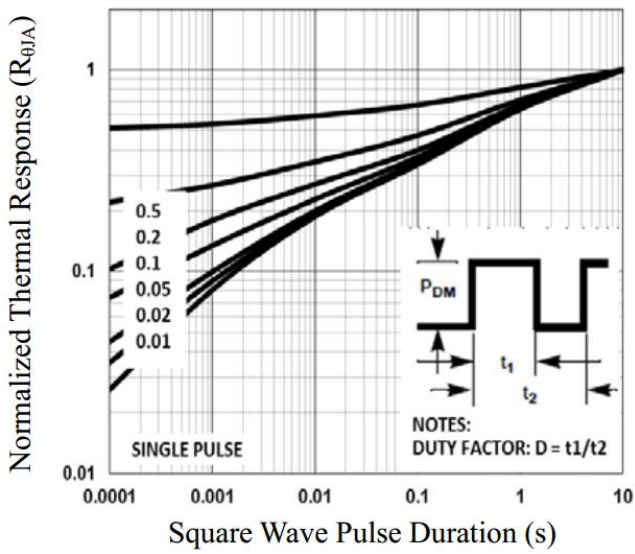


Fig.5 Normalized Transient Impedance

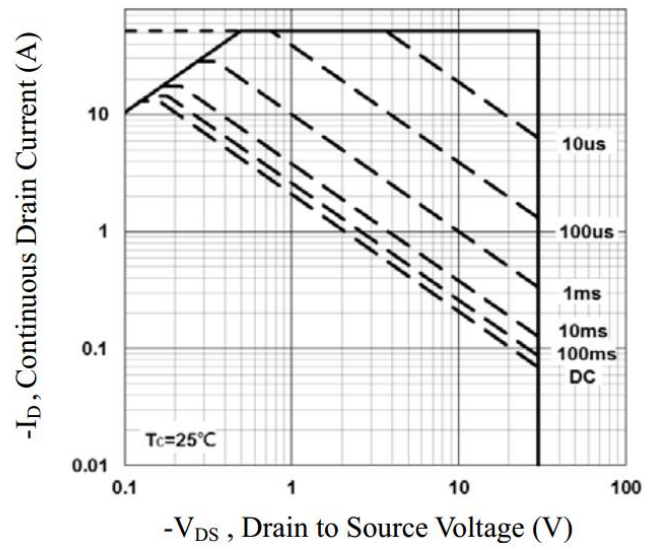


Fig.6 Maximum Safe Operation Area

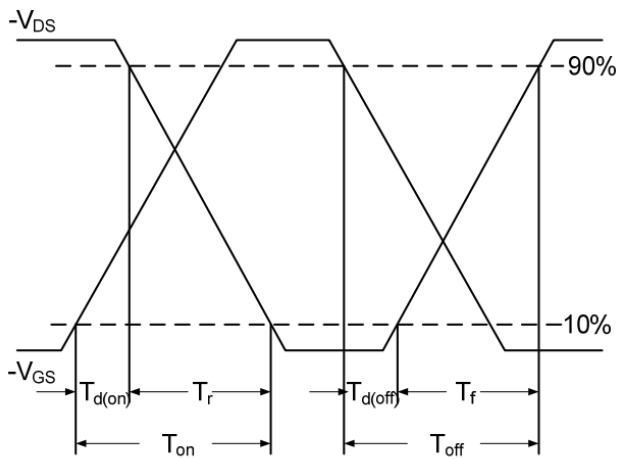


Fig.7 Switching Time Waveform

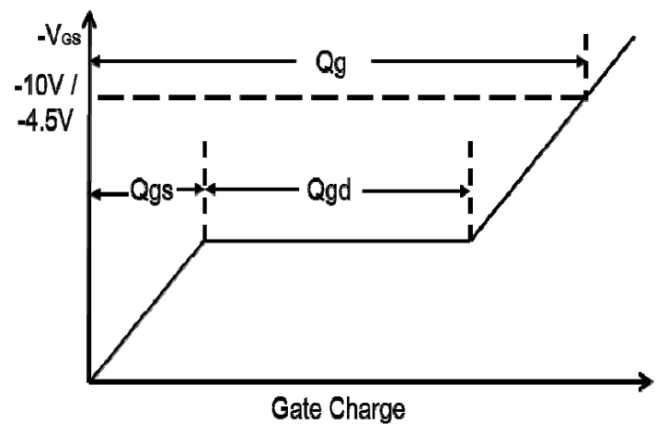
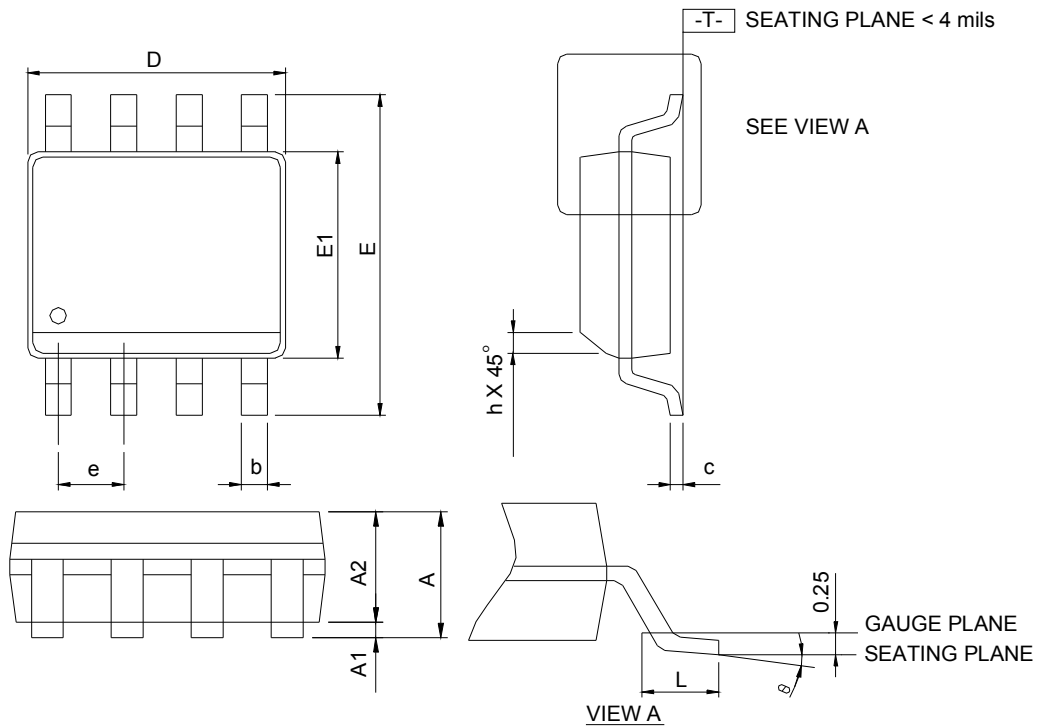


Fig.8 Gate Charge Waveform

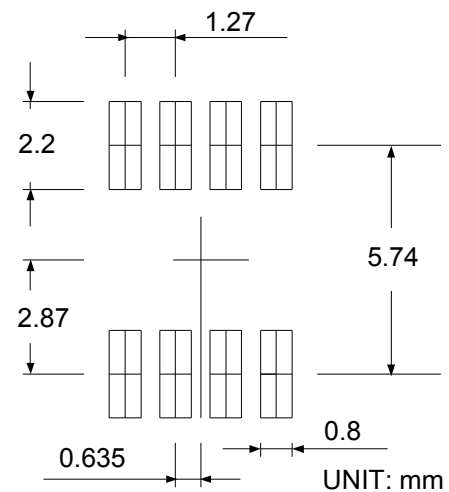
Package Information

SOP-8



DIMENSIONS	SOP-8			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	-	1.75	-	0.069
A1	0.10	0.25	0.004	0.010
A2	1.25	-	0.049	-
b	0.31	0.51	0.012	0.020
c	0.17	0.25	0.007	0.010
D	4.80	5.00	0.189	0.197
E	5.80	6.20	0.228	0.244
E1	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
h	0.25	0.50	0.010	0.020
L	0.40	1.27	0.016	0.050
θ	0°	8°	0°	8°

RECOMMENDED LAND PATTERN



- Note: 1. Follow JEDEC MS-012 AA.
 2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.
 3. Dimension "E" does not include inter-lead flash or protrusions. Inter-lead flash and protrusions shall not exceed 10 mil per side.